

CM9V-T1A 0.3

Product Documentation

CM9V-T1A 0.3

Quartz Crystal Unit 32.768 kHz

2. Product Description

The CM9V-T1A 0.3 is an ultra low profile, low frequency SMD Quartz Crystal Unit that incorporates a tuning fork Quartz Crystal Resonator. The Quartz Crystal Resonator operates under vacuum condition in a hermetically sealed ceramic package with metal lid.

Suitable oscillator-circuitries can operate the CM9V-T1A 0.3 Quartz Crystal Units in fundamental mode consuming very low power. For technical assistance for optimizing oscillator-circuitries please contact Micro Crystal under sales@microcrystal.com

2.1. Application Examples

IoT Industrial Health Care Smart Cards Ultra Thin Devices Wearables, Portables

2.2. Ordering Information

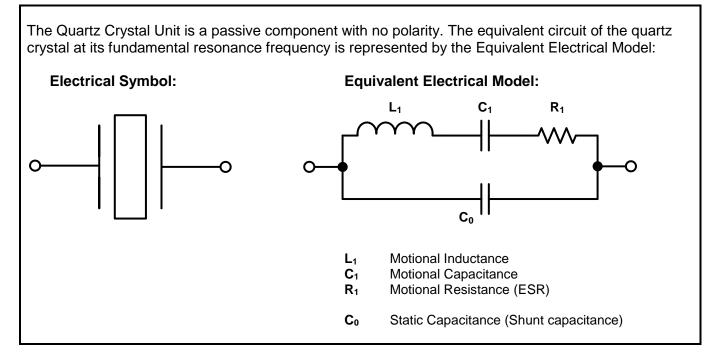
Example: CM9V-T1A 0.3 32.768 kHz CL: 12.5 pF -20/+20ppm TA QC

Code	Operating temperature range
TA (Standard)	-40 to +85°C
ТВ	-40 to +125°C
TC	-55 to +125°C

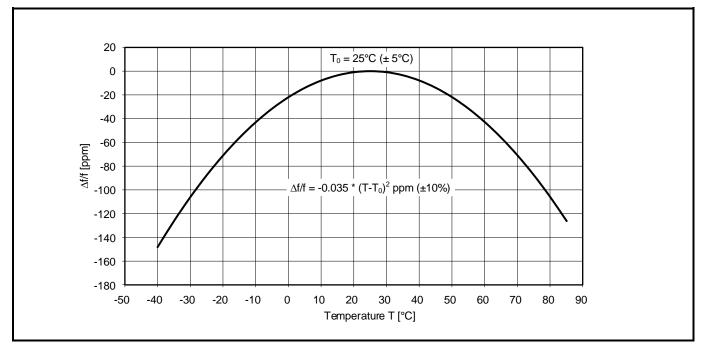
Code	Qualification
QC (Standard)	Commercial Grade

3. Electrical Characteristics

3.1. Equivalent Electrical Model

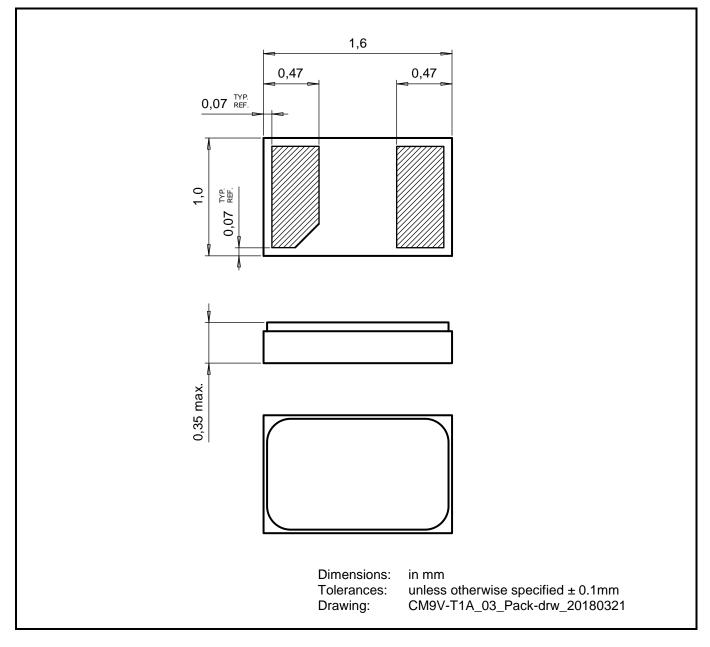


3.2. Frequency vs Temperature Characteristics

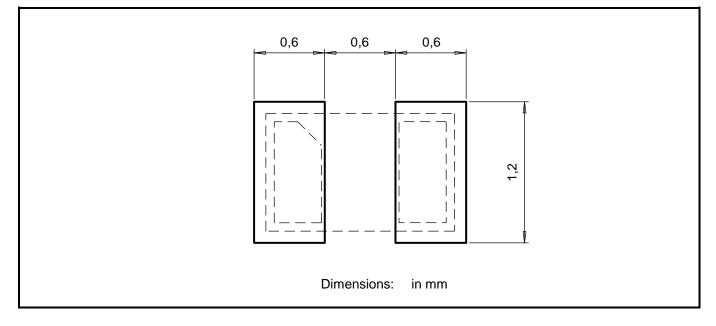


4. Mechanical Properties

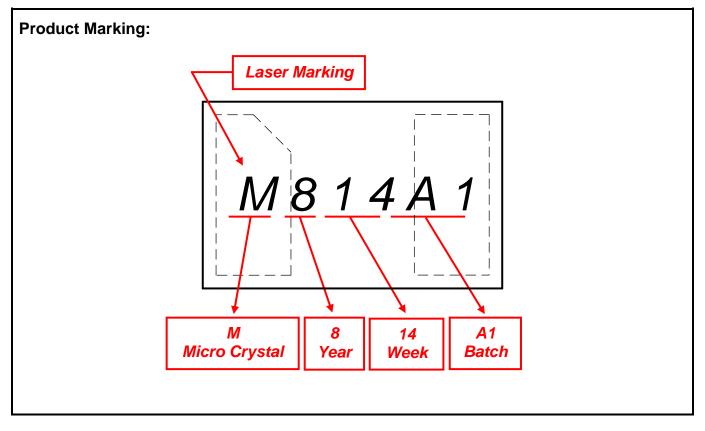
4.1. Package Dimension



4.2. Recommended Solderpad Layout



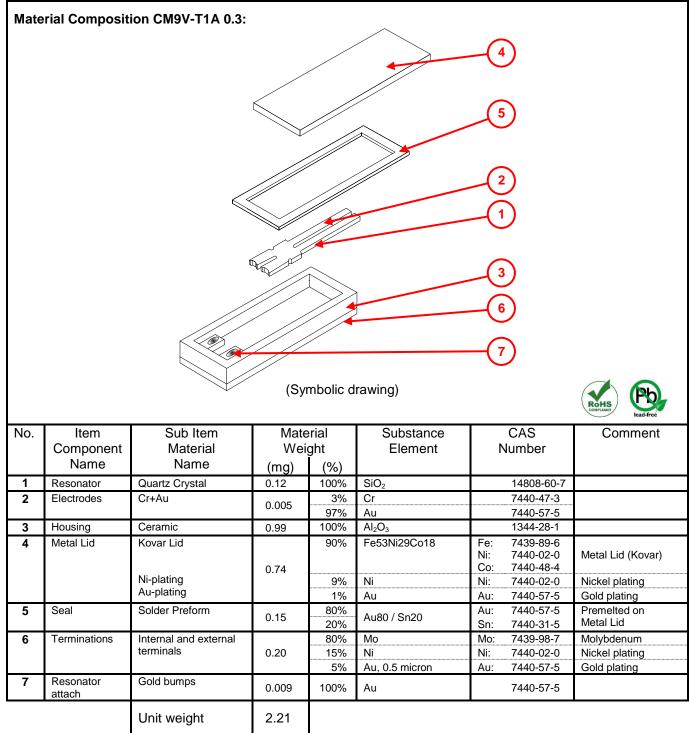
4.3. Product Marking



5. Material Composition Declaration & Environmental Information

5.1. Homogenous Material Composition Declaration

Homogenous material information according to IPC-1752 standard



5.2. Material Analysis & Test Results

Homogenous material information according to IPC-1752 standard

No.	ltem	Sub Item		RoHS				Halogens			Phthalates					
	Component Name	Material Name	Pb	Cd	Hg	Cr(VI)	PBB	PBDE	Ŀ	CI	Br	_	BBP	DBP	DEHP	DIBP
1	Resonator	Quartz Crystal	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
2	Electrodes	Cr+Au	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
3	Housing	Ceramic	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
4	Metal Lid	Kovar Lid & Plating	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
5	Seal	Solder Preform	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
6	Terminations	Int. & ext. terminals	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
7	Resonator attach	Gold bumps	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
	MDL [ppm]	Method Detection Limit		2		8	Ę	5		5	0			5	0	

Test methods:

nd (not detected) = below "Method Detection Limit" (MDL)

RoHS	Test method with reference to:					
 Pb, Cd 	IEC 62321-5:2013	MDL:	2 ppm			
• Hg	IEC 62321-4:2013 + AMD1:2017	MDL:	2 ppm			
 Cr(VI) 	IEC 62321-7-2:2017	MDL:	8 ppm			
PBB / PBDE	IEC 62321-6:2015	MDL:	5 ppm			
Halogens	Test method with reference to BS EN 14582:2016	MDL:	50 ppm			
Phthalates	Test method with reference to IEC 62321-8:2017	MDL:	50 ppm			

5.3. Recycling Material Information

Recycling material information according to IPC-1752 standard.

Element weight is accumulated	and referenced to the	unit weight of 2.21 mg.

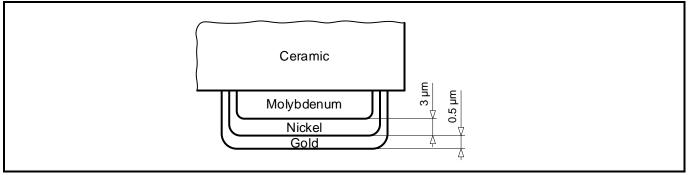
Item Material	No.	Item Component		erial ight	Substance Element	CAS Number	Comment
Name		Name	(mg)	(%)			
Quartz Crystal	1	Resonator	0.12	5.42	SiO ₂	14808-60-7	
Chromium	2	Electrodes	0.00015	0.007	Cr	7440-47-3	
Ceramic	3	Housing	0.99	44.72	AI_2O_3	1344-28-1	
Gold	2 4 5 6 7	Electrodes Metal Lid Seal Terminations Resonator attach	0.15	6.83	Au	7440-57-5	
Tin	5	Seal	0.03	1.36	Sn	Sn: 7440-31-5	
Nickel	4 6	Metal Lid (Plating) Terminations	0.097	4.36	Ni	Ni: 7440-02-0	
Molybdenum	6	Terminations	0.16	7.23	Мо	Mo: 7439-98-7	
Kovar	4	Metal Lid	0.67	30.08	Fe53Ni29Co18	Fe: 7439-89-6 Ni: 7440-02-0 Co: 7440-48-4	
	Unit v	veight (total)	2.21	100			

5.4. Environmental Properties & Absolute Maximum Ratings

Package	Description					
Ceramic Package	Hermetically sealed ceramic pack	Hermetically sealed ceramic package with metal lid, no-leads				
Parameter	Directive	Conditions	Value			

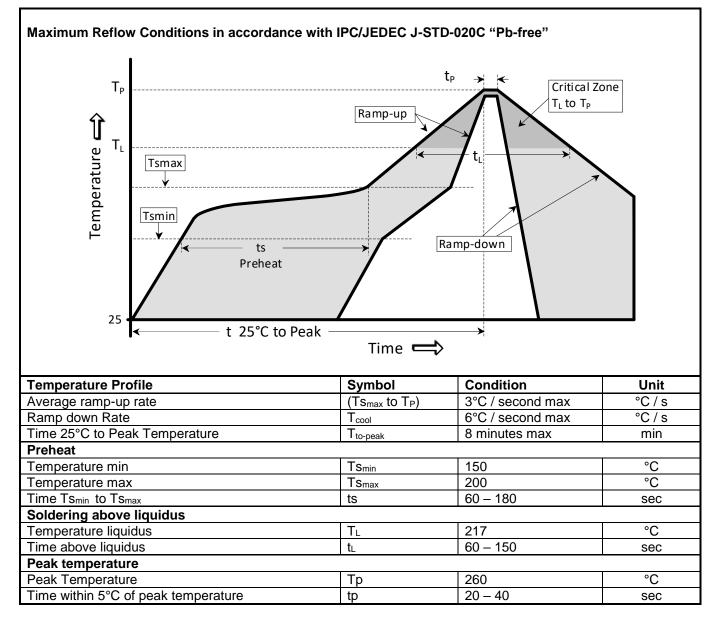
Product weight (total)			2.21 mg
Storage temperature		Store as bare product	-55 to +125°C
Moisture sensitivity level (MSL)	IPC/JEDEC J-STD-020D		MSL 1
FIT / MTBF			available on request

Terminal finish:



6. Application Information

6.1. Soldering Information



6.2. Handling Instructions for Quartz Crystal Units

The built-in tuning-fork crystal consists of pure Silicon Dioxide in crystalline form. The cavity inside the package is evacuated and hermetically sealed in order for the crystal blank to function undisturbed from air molecules, humidity and other influences.

Shock and vibration:

Keep the crystal / module from being exposed to **excessive mechanical shock and vibration**. Micro Crystal guarantees that the crystal / module will bear a mechanical shock of 5000 g / 0.3 ms.

The following special situations may generate either shock or vibration:

Multiple PCB panels - Usually at the end of the pick & place process the single PCBs are cut out with a router. These machines sometimes generate vibrations on the PCB that have a fundamental or harmonic frequency close to 32.768 kHz. This might cause breakage of crystal blanks due to resonance. Router speed should be adjusted to avoid resonant vibration.

Ultrasonic cleaning - Avoid cleaning processes using ultrasonic energy. These processes can damage the crystals due to the mechanical resonance frequencies of the crystal blank.

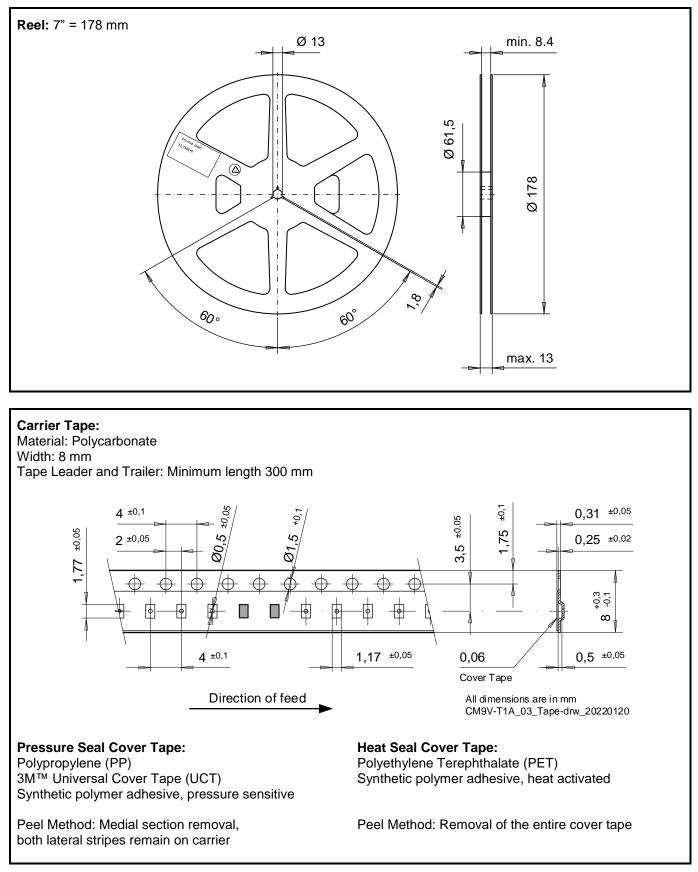
Overheating, rework high temperature exposure:

Avoid overheating the package. The package is sealed with a seal ring consisting of 80% Gold and 20% Tin. The eutectic melting temperature of this alloy is at 280°C. Heating the seal ring up to >280°C will cause melting of the metal seal which then, due to the vacuum, is sucked into the cavity forming an air duct. This happens when using hot-air-gun set at temperatures >280°C.

Use the following methods for rework:

- Use a hot-air-gun set at 270°C.
- Use 2 temperature controlled soldering irons, set at 270°C, with special-tips to contact all solder-joints from both sides of the package at the same time, remove part with tweezers when pad solder is liquid.

7. Packing & Shipping Information



8. Compliance Information

Micro Crystal confirms that the standard product Quartz Crystal Unit CM9V-T1A 0.3 is compliant with "EU RoHS Directive" and "EU REACh Directives".

Please find the actual Certificate of Conformance for Environmental Regulations on our website: <u>CoC_Environment_CC&CM-Series.pdf</u>

9. Document Revision History

Date	Revision #	Revision Details
April 2018	1.0	First release
January 2022	1.1	Added "ultra low profile", 2. Changed term "SMT" to "SMD", 2. Added "∆f/f = " at formula and "T" at X axis, 3.2. Added "Dimensions: in mm", 4.1. and 4.2. Adapted limit values and methods in accordance with the latest standards, 5.2. Completed to "Hermetically sealed ceramic package with metal lid, no-leads", 5.4. Corrected text to "hot-air-gun set at temperatures >280°C.", 6.2. Adapted Cover/Carrier Tape height (0,06/0,31), 7. Added specification for Heat Seal Cover Tape, 7. Updated CoC Hyperlink, 8. Added new disclaimer

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Micro Crystal AG Muehlestrasse 14 CH-2540 Grenchen Switzerland Phone +41 32 655 82 82 sales@microcrystal.com www.microcrystal.com